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Olsson et al.

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(54) **LED LIGHTS FOR DEEP OCEAN USE**

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CPC *F21V 31/005* (2013.01); *F21V 3/00* (2013.01); *F21V 15/01* (2013.01); *F21V 23/005* (2013.01); *F21V 29/70* (2015.01); *F21V 29/83* (2015.01); *B63G 8/00* (2013.01); *F21Y 2101/00* (2013.01); *F21Y 2115/10* (2016.08)

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(58) **Field of Classification Search**
CPC combination set(s) only.
See application file for complete search history.

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(21) Appl. No.: **16/011,150**

(22) Filed: **Jun. 18, 2018**

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Related U.S. Application Data

(63) Continuation of application No. 15/362,609, filed on Nov. 28, 2016, now Pat. No. 10,066,828, which is a continuation of application No. 14/139,851, filed on Dec. 23, 2013, now Pat. No. 9,512,988, which is a continuation of application No. 13/236,561, filed on Sep. 19, 2011, now Pat. No. 8,616,725.

(60) Provisional application No. 61/384,128, filed on Sep. 17, 2010.

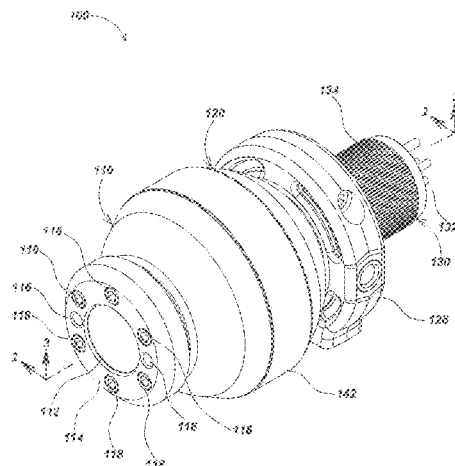
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(51) **Int. Cl.**
A63B 45/00 (2006.01)
F21V 31/00 (2006.01)
F21V 23/00 (2015.01)
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F21V 29/83 (2015.01)
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F21V 15/01 (2006.01)
B63G 8/00 (2006.01)

(57) **ABSTRACT**

An underwater LED light for use in high ambient pressure environments having a housing, a transparent pressure-bearing window, an MCPCB having one or more LEDs, and a multilayer stack of spacers for carrying loads applied to the window to the MCPCB and to the housing.

1 Claim, 13 Drawing Sheets



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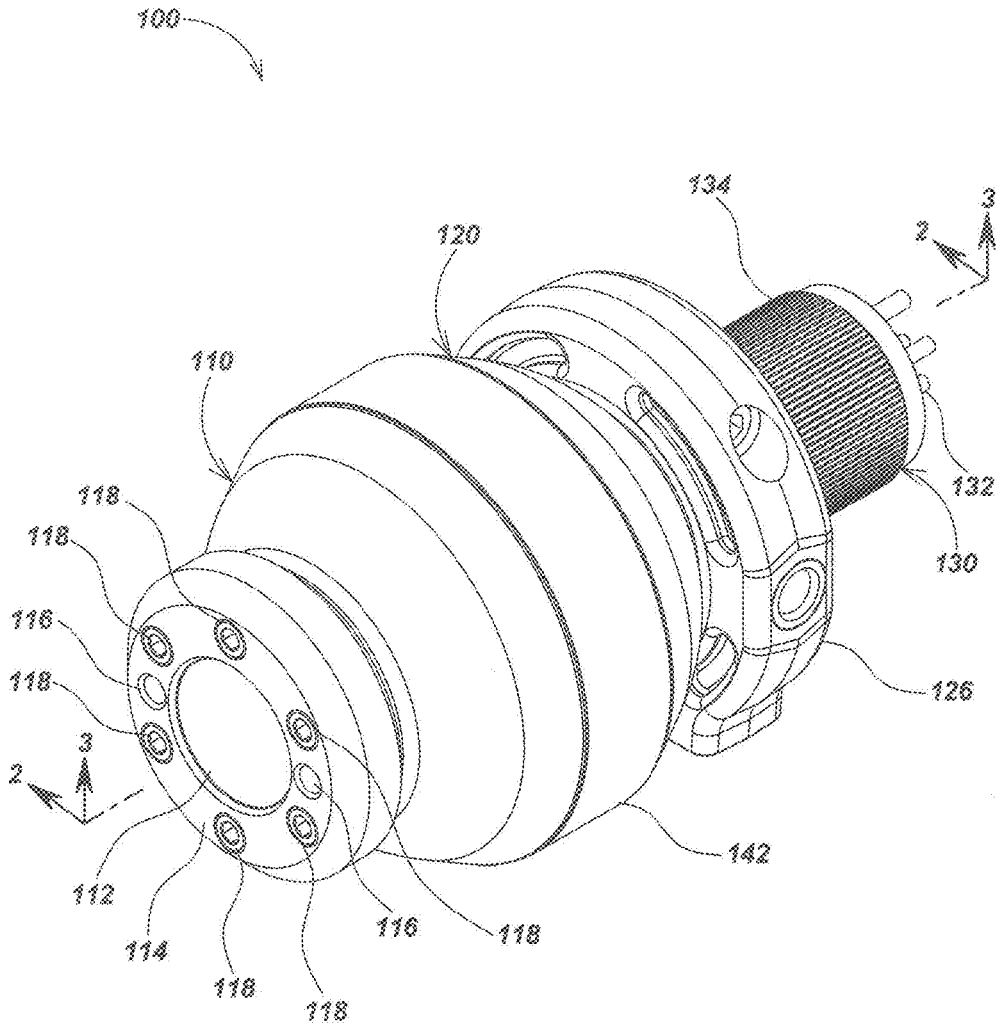


FIG. 1

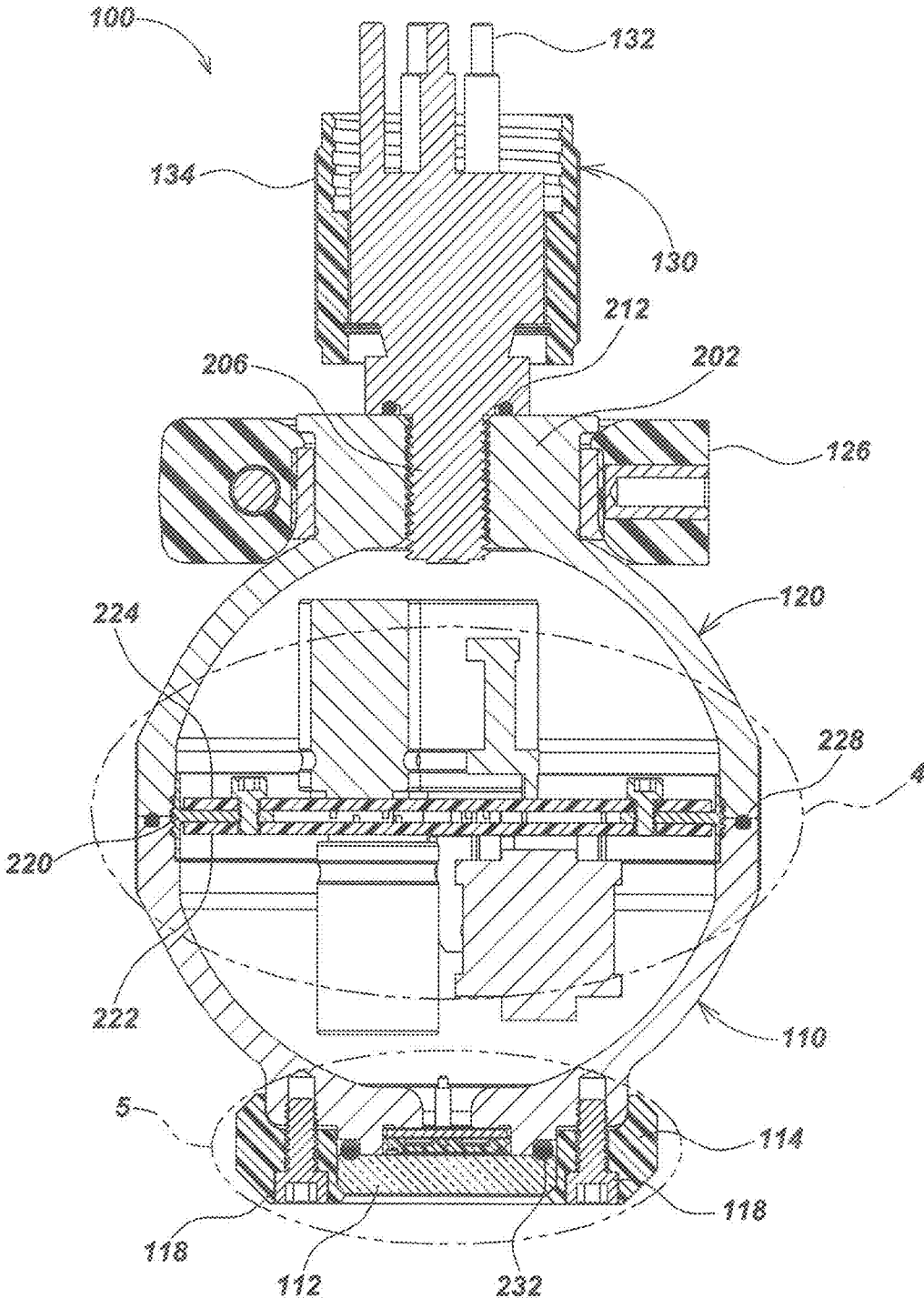


FIG. 2

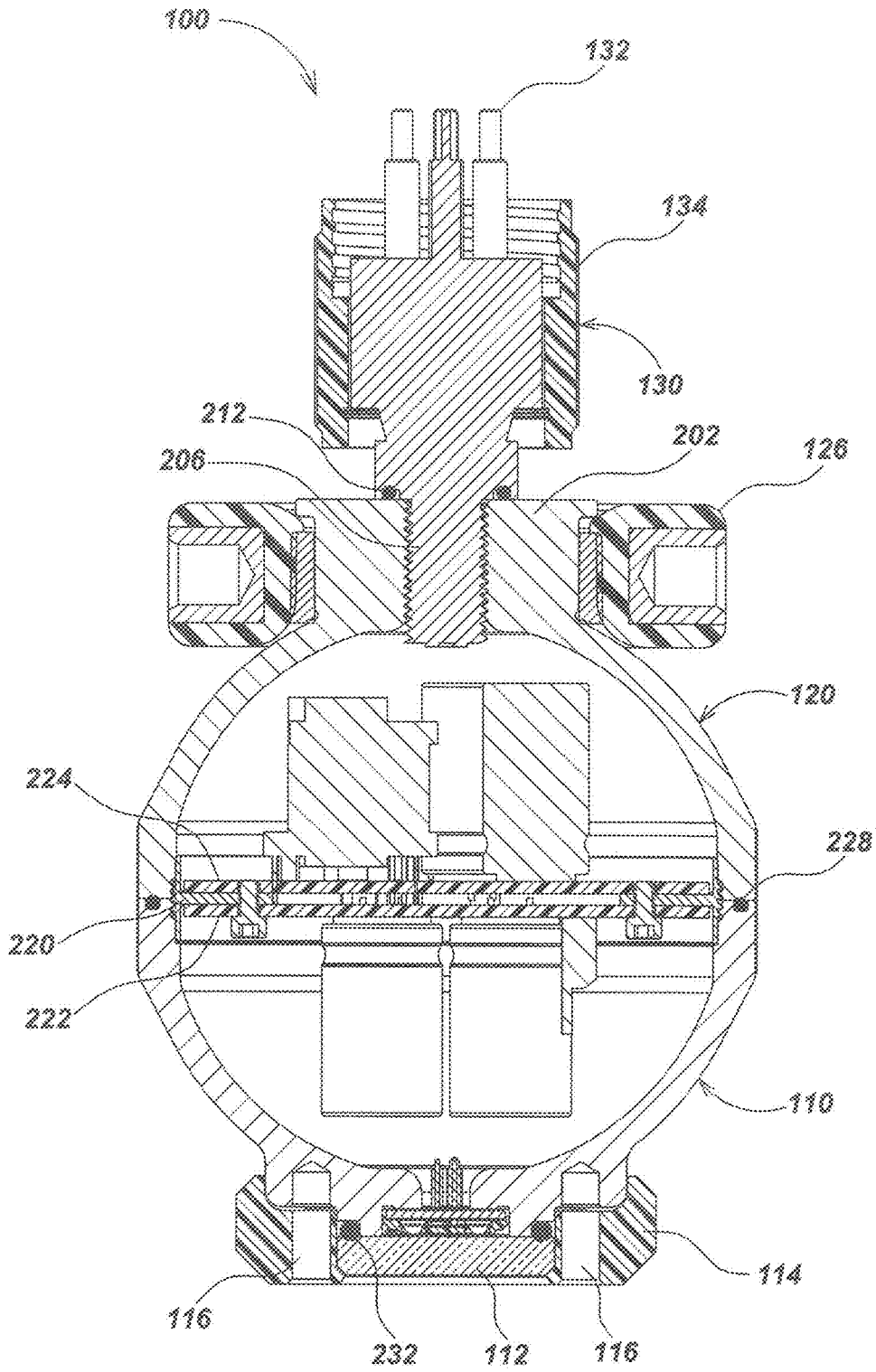


FIG. 3

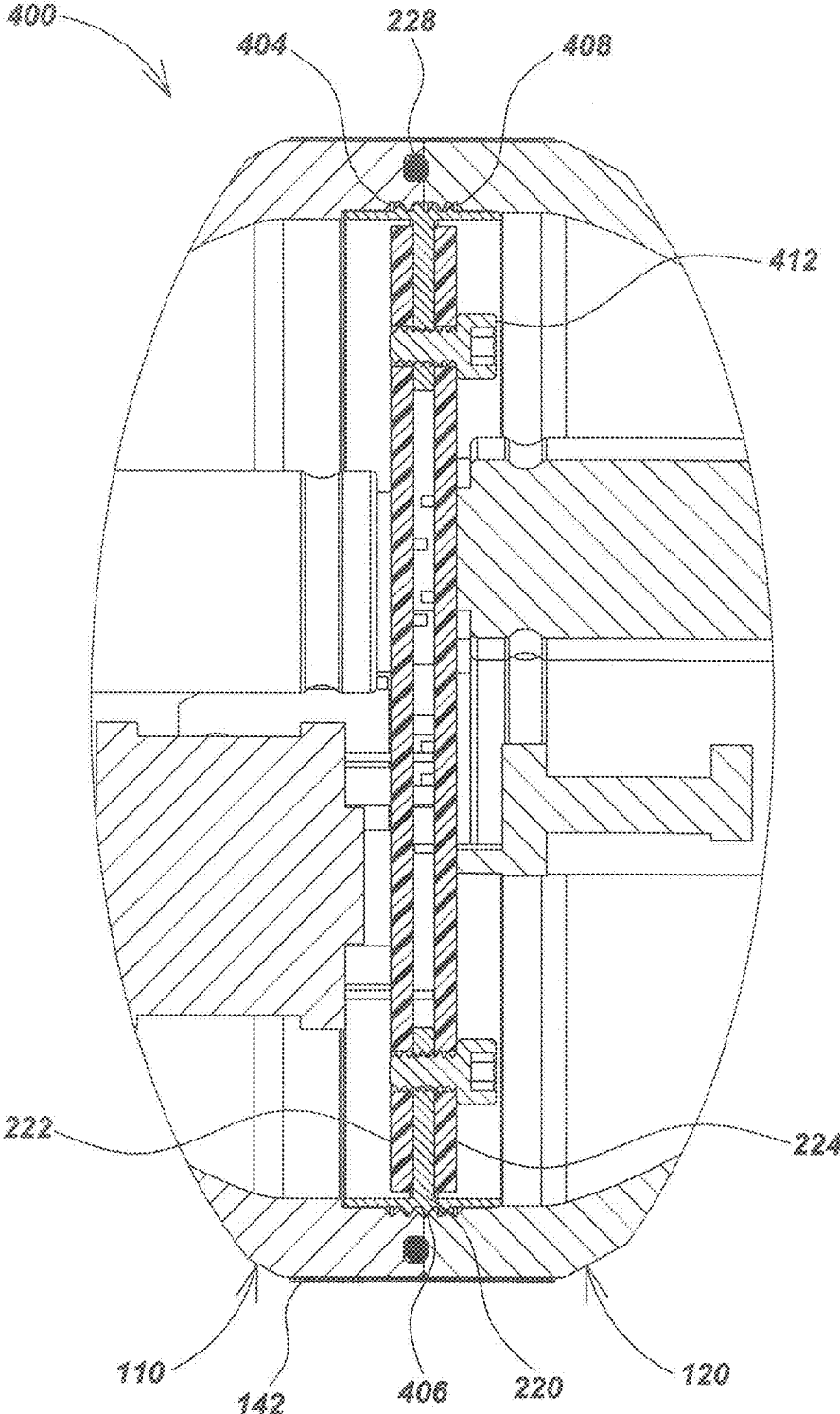


FIG. 4

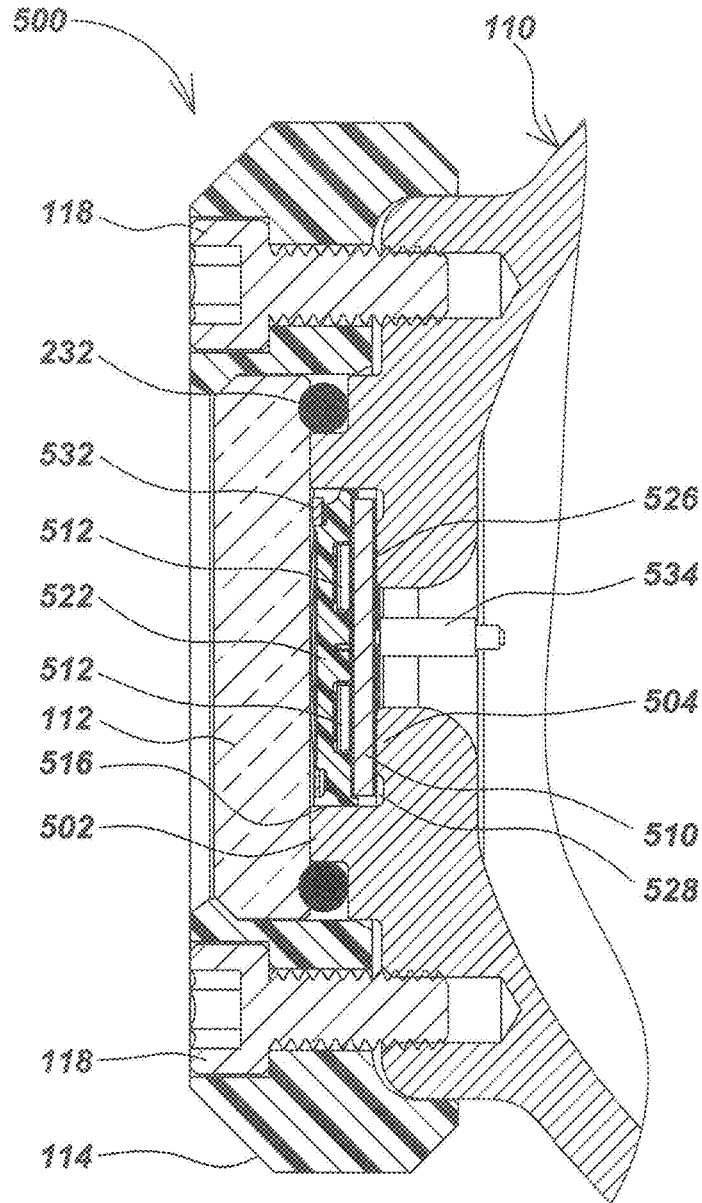


FIG. 5

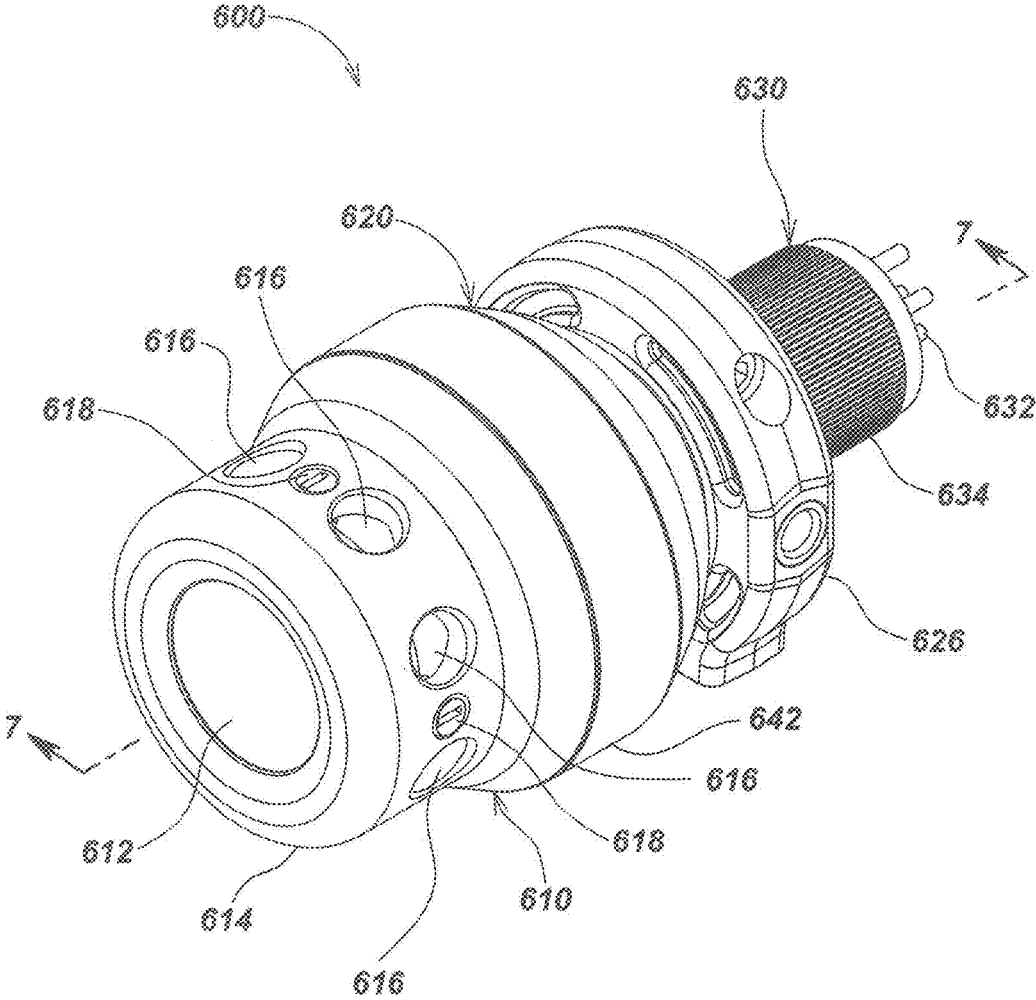


FIG. 6

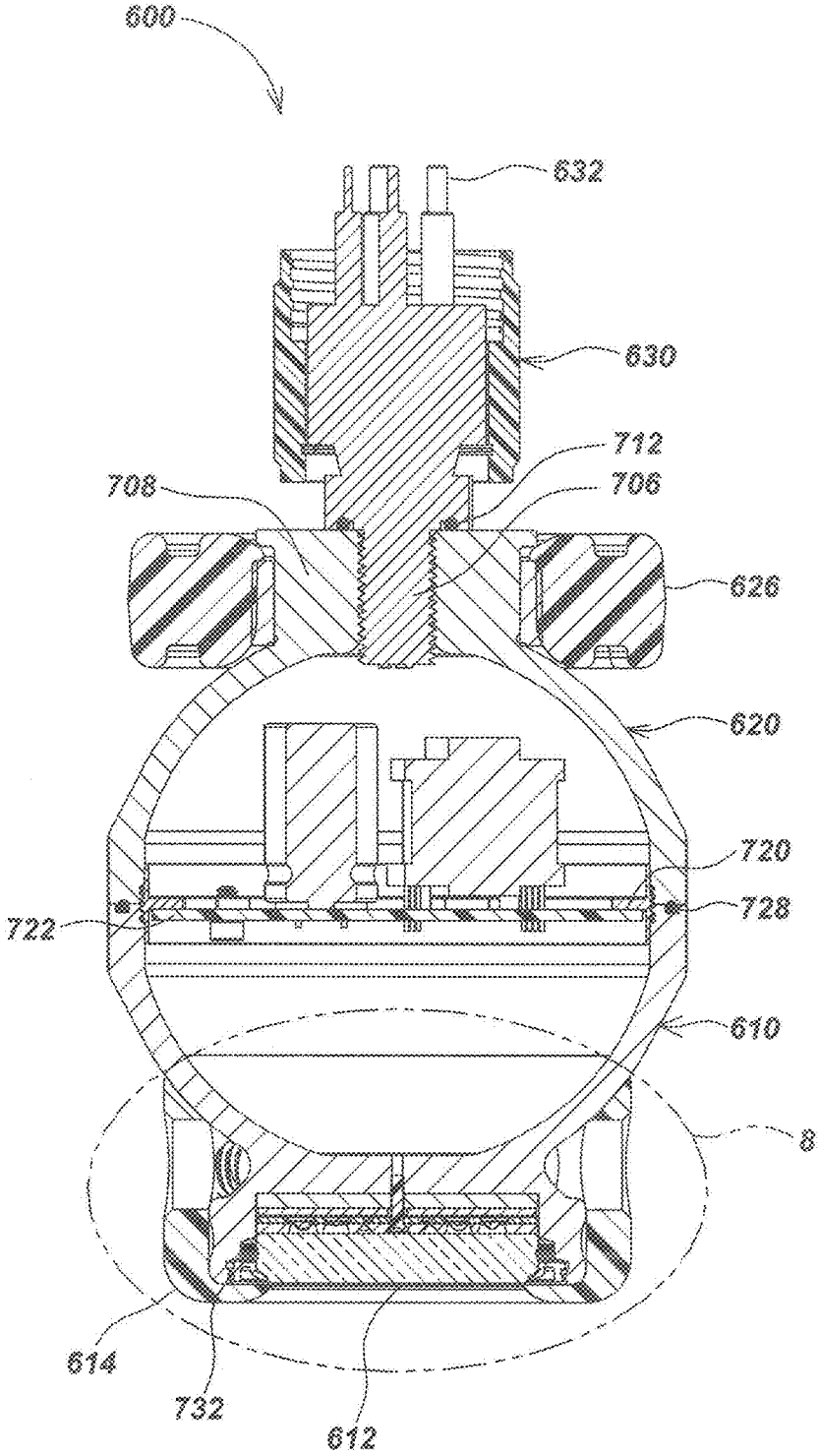


FIG. 7

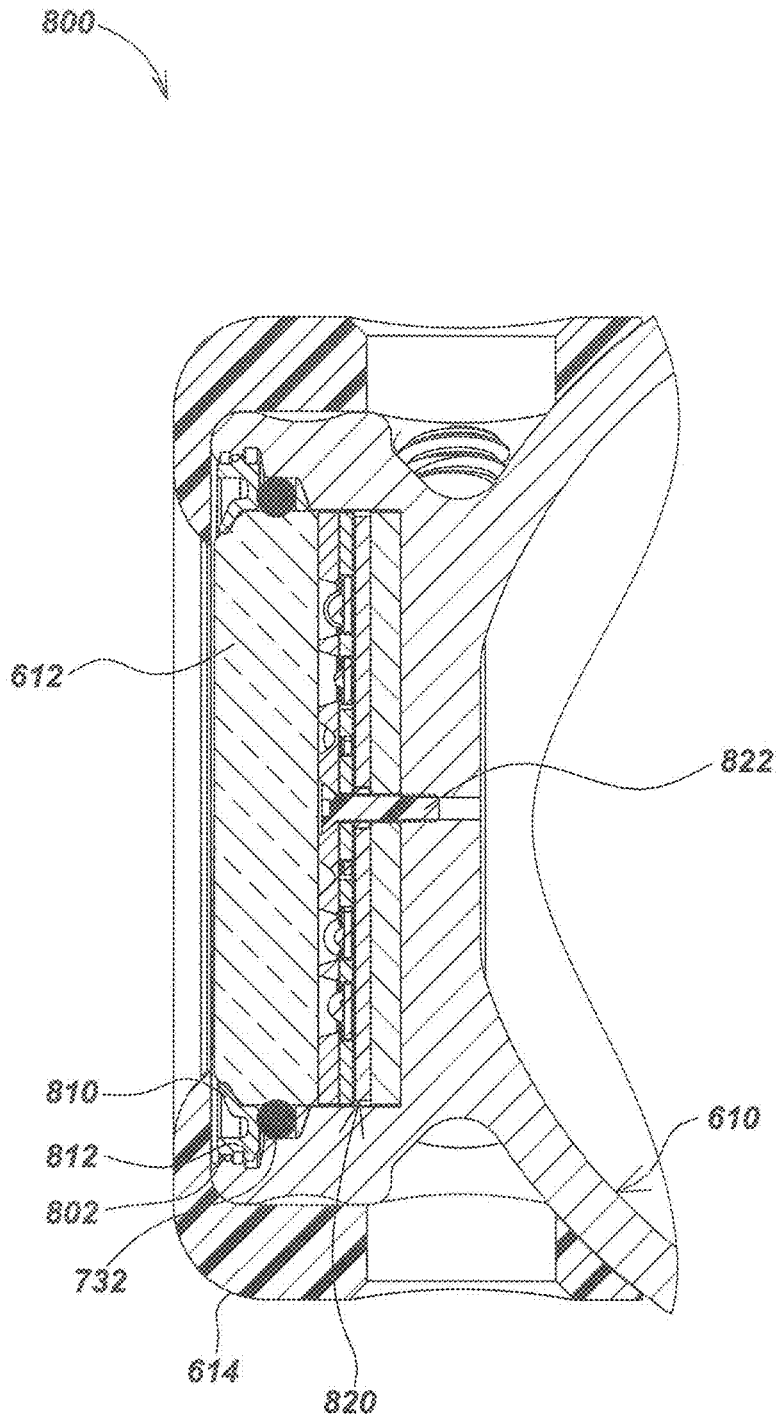


FIG. 8

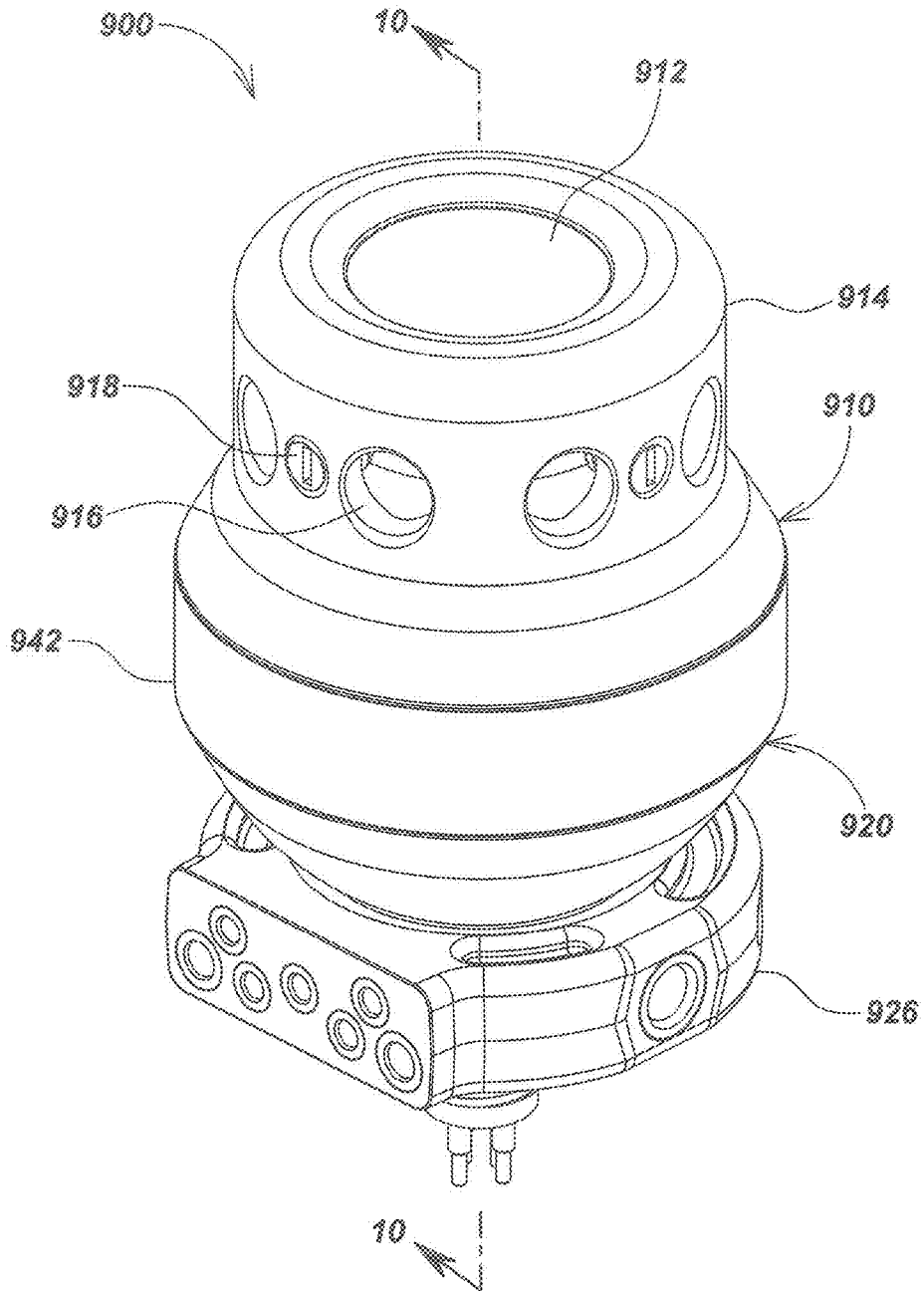


FIG. 9

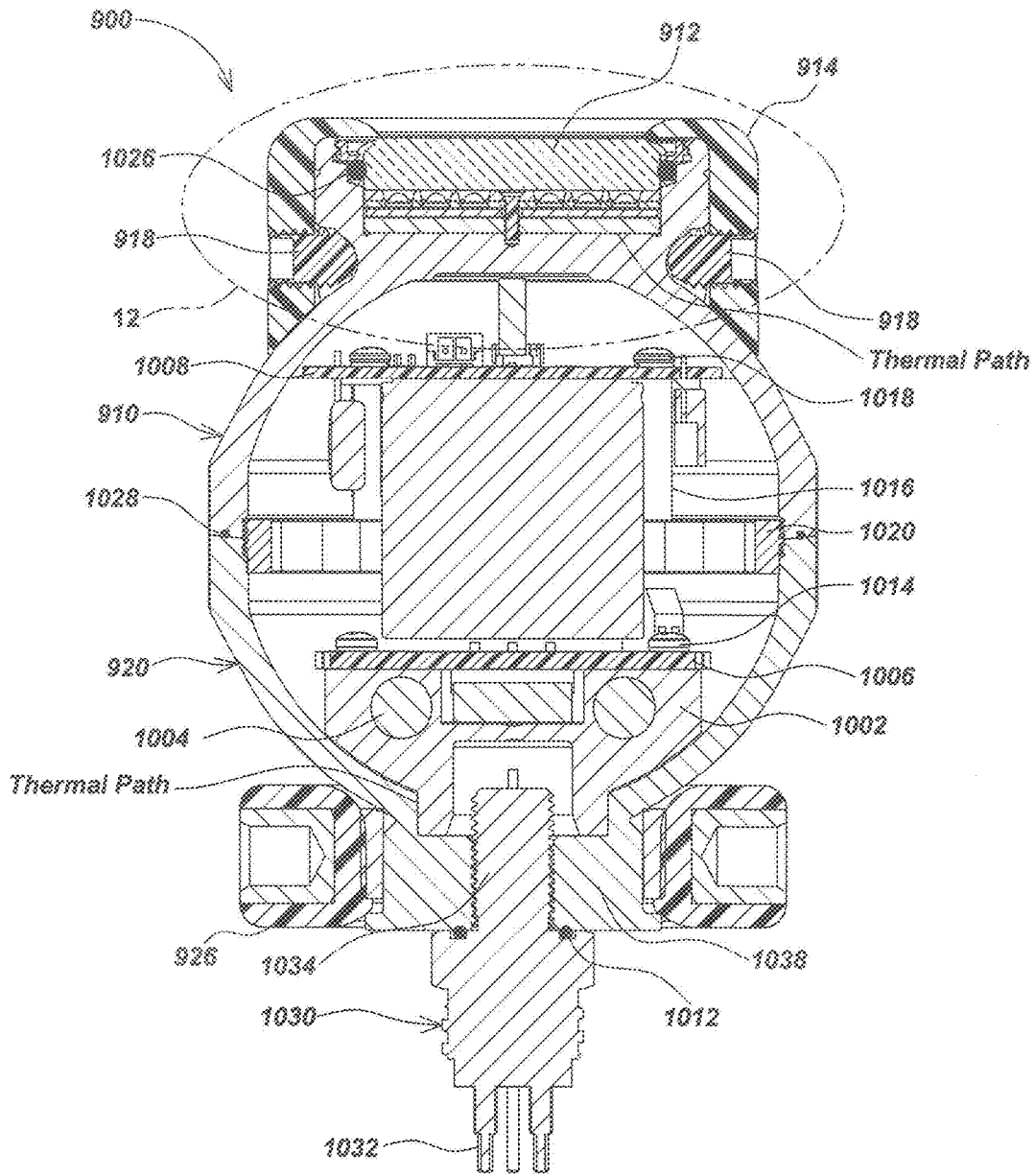


FIG. 10

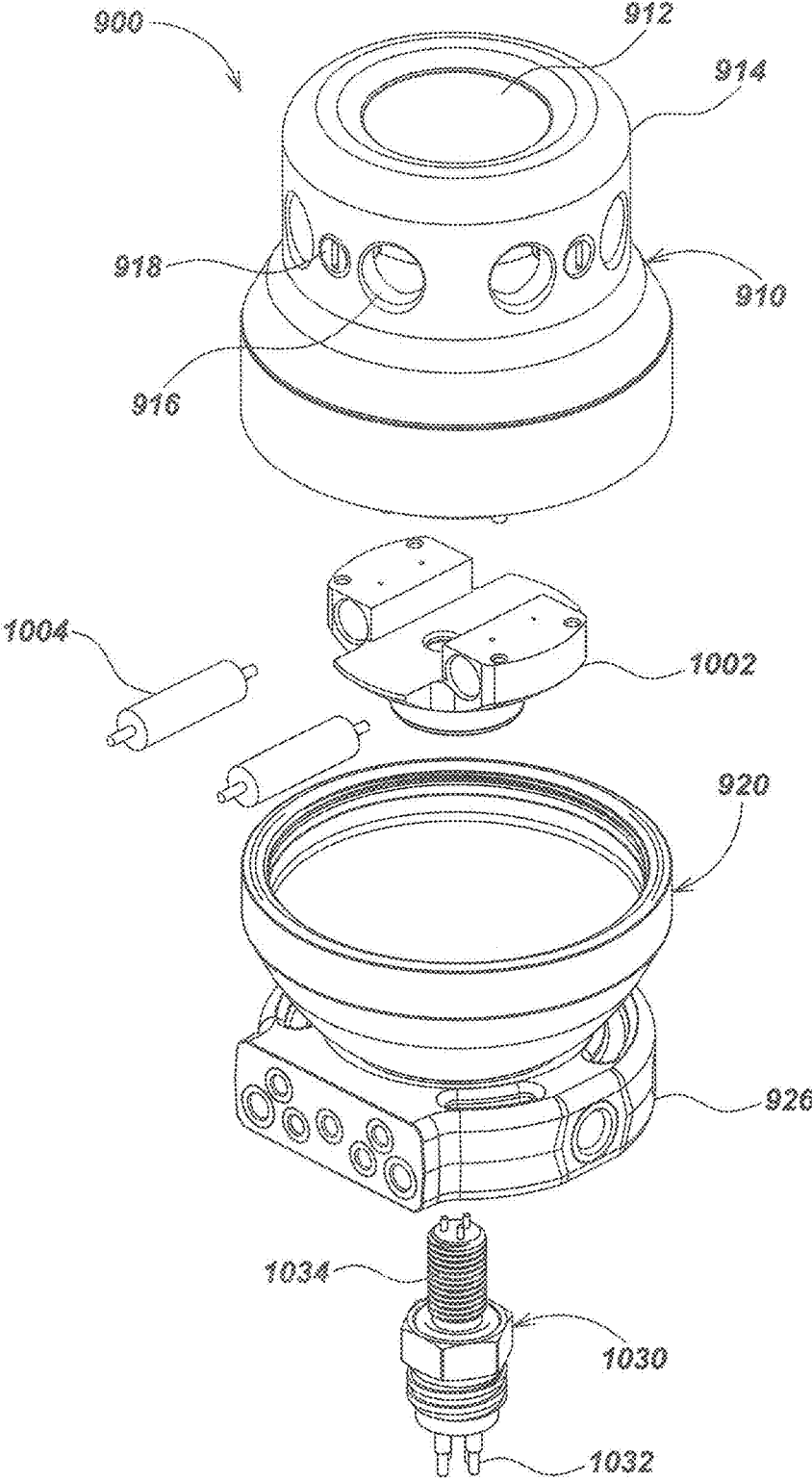


FIG. 11

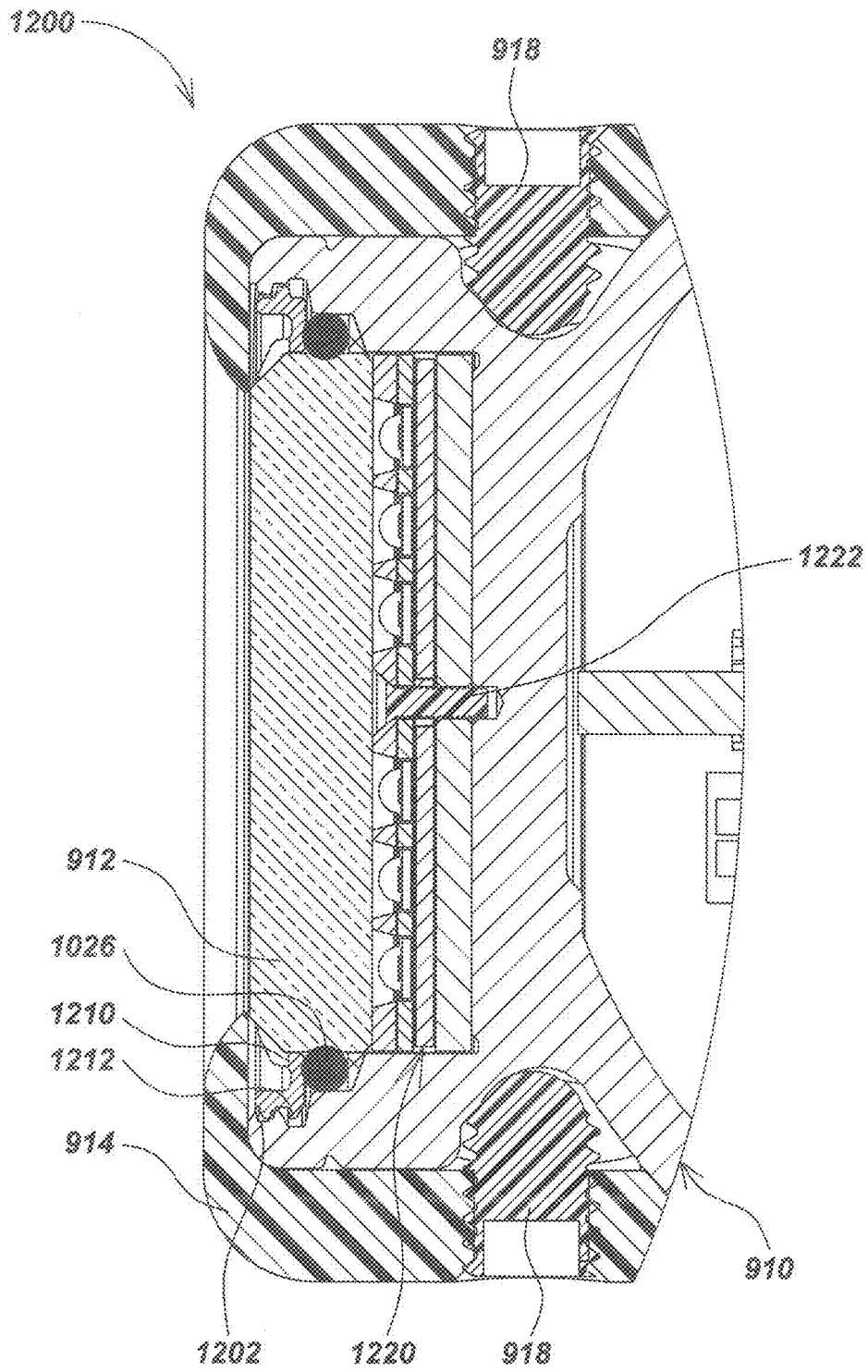


FIG. 12

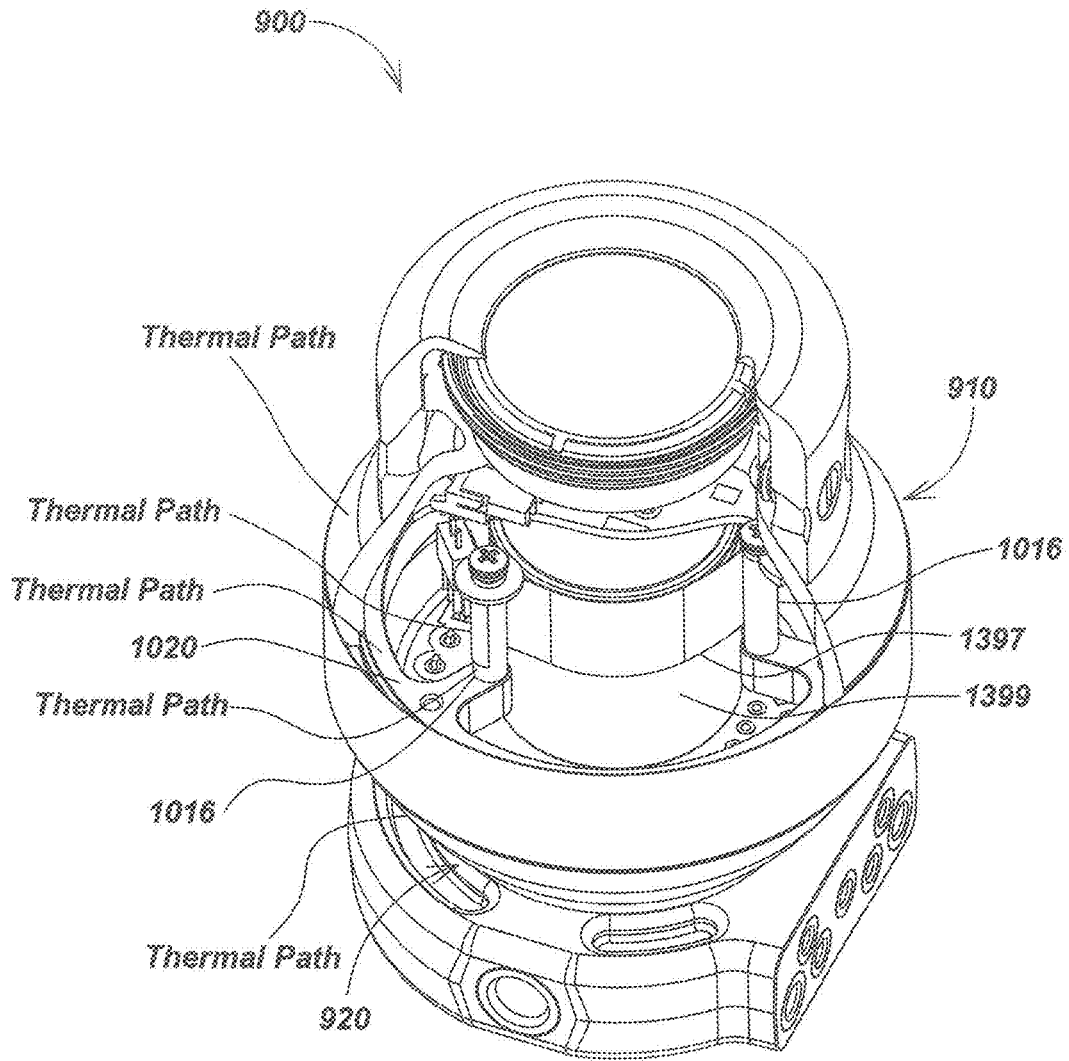


FIG. 13

LED LIGHTS FOR DEEP OCEAN USE**CROSS-REFERENCE TO RELATED APPLICATIONS**

This application is a continuation of and claims priority to U.S. Utility patent application Ser. No. 15/362,609, entitled LED LIGHTS FOR DEEP OCEAN USE, filed Nov. 28, 2016, which is a continuation of and claims priority to U.S. Utility patent application Ser. No. 14/139,851, entitled LED LIGHT FIXTURES WITH ENHANCED HEAT DISSIPATION, filed Dec. 23, 2013, which claims priority to U.S. Utility patent application Ser. No. 13/236,561, entitled LED SPHERICAL LIGHT FIXTURES WITH ENHANCED HEAT DISSIPATION, filed Sep. 19, 2011, which claims priority under 35 U.S.C. § 119(e) to U.S. Provisional Patent Application Ser. No. 61/384,128, entitled LED SPHERICAL LIGHT FIXTURES WITH ENHANCED HEAT DISSIPATION, filed Sep. 17, 2010. The content of each of these applications is incorporated by reference herein in its entirety.

FIELD

The present disclosure relates generally to LED light fixtures for use in deep water environments. More specifically, but not exclusively, this disclosure relates to LED light fixtures configured with a substantially or partially spherical housing to provide enhanced heat dissipation.

BACKGROUND

Semiconductor LEDs have largely replaced conventional incandescent, fluorescent and halogen lighting sources in many applications due to their long life, ruggedness, color rendering, efficacy, and compatibility with other solid state devices. In marine applications, for example, light emitting diodes (LEDs) are emerging as a desired light source for their energy efficiency, instant on-off characteristics, color purity, and vibration resistance.

LEDs are an efficient light source widely available, having surpassed High Intensity Discharge (HID) lamps in lumens per watt. Different uses of LEDs in various light applications, including use of LEDs in marine environments, offer unique advantages and disadvantages.

For example, LEDs designed to deliver high levels of brightness suffer from problems associated with heat dissipation and inefficient distribution of light for certain applications. While these high brightness LEDs are significantly more efficient than incandescent systems or gas-filled (halogen or fluorescent) systems, they still dissipate on the order of 50% of their energy in heat. If this heat is not managed, it can induce thermal-runaway conditions within the LED, resulting in their failure. For situations requiring high levels of lighting, this situation is aggravated by combining many high brightness LEDs in a tight geometrical pattern within a light-source structure. Heat management becomes a primary constraint for applications seeking to use the other advantages of high brightness LEDs as a source of illumination.

For example, underwater lighting devices that use LEDs may require configurations that compensate for ambient pressure and/or rising internal temperature in order to avoid catastrophic failure of all or a portion of the lighting device. Such configurations may use a pressure-protected housing to isolate the LEDs from the ambient pressure, or may immerse the LEDs in a fluid-filled temperature compensation environment to provide thermal management.

However, the disadvantages of fluid-filling an LED light may include decreased light beam control and increased contamination of the LED phosphor coating. Thus, protecting LEDs from the external pressure and excess internal temperature using a pressure-protected and thermally-efficient housing is desired.

Accordingly, there is a need in the art to address the above-described and other problems.

SUMMARY

The present disclosure relates generally to LED light fixtures configured with a substantially or partially spherical housing to provide enhanced heat dissipation.

In one aspect, this disclosure relates to a LED light fixture. The LED light fixture may be configured to provide enhanced or improved heat dissipation during operation in deep water environments.

The LED light fixture may include, for example, a housing, which may be made of metal and may include a front and a rear section. The housing may have a hollow interior and an aperture extending through a front side of the housing. A transparent window may extend across the aperture. An LED may be disposed in the housing.

Various additional aspects, features, and functionality are further described below in conjunction with the appended Drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

The present application may be more fully appreciated in connection with the following detailed description taken in conjunction with the accompanying drawings, wherein:

FIG. 1 is an isometric view of an embodiment of an underwater spherical LED light fixture;

FIG. 2 is a longitudinal section view of the underwater spherical LED light fixture embodiment of FIG. 1, taken along line 2-2;

FIG. 3 is a longitudinal section view of the underwater spherical LED light fixture embodiment of FIG. 1, taken along line 3-3;

FIG. 4 is an enlarged detail view of an equatorial region of the underwater spherical light fixture embodiment as shown in FIG. 2 and designated as illustrative section 4;

FIG. 5 is an enlarged detail view of an embodiment of a LED light fixture sub-assembly as shown in FIG. 2.

FIG. 6 is an isometric view of an alternate embodiment underwater LED light fixture;

FIG. 7 is a longitudinal sectional side view of the alternate embodiment underwater LED light fixture of FIG. 6, taken along line 7-7;

FIG. 8 is an enlarged detail view of an alternate embodiment LED light fixture sub-assembly as shown in FIG. 7;

FIG. 9 is an isometric view of an alternate embodiment underwater LED light fixture;

FIG. 10 is a vertical section view of the alternate embodiment LED light fixture of FIG. 9, taken along line 10-10;

FIG. 11 is an exploded isometric view of details of the alternate embodiment LED light fixture as shown in FIG. 9;

FIG. 12 is an enlarged detail view of an alternate embodiment LED light fixture sub-assembly as shown in FIG. 10; and

FIG. 13 is a three-dimensional view of an alternate embodiment LED light fixture sub-assembly as shown in FIG. 10.

DETAILED DESCRIPTION OF EMBODIMENTS

Overview

The present disclosure relates generally to LED spherical light fixtures. In one aspect, the present disclosure relates to embodiments of an LED spherical light fixture with reduced weight and enhanced heat dissipation.

The LED light fixtures of the present disclosure may be configured for deep submersible applications that require a lightweight assembly and can withstand high pressure environment at significant ocean depths, e.g. 1400 meters and deeper. The LED light fixtures of the present disclosure may conduct the heat generated from an LED driver circuit laterally through a printed circuit board (PCB), a metal outer housing, and then out into the cold surrounding ocean.

Those of skill in the art will appreciate that various thermally-conductive materials may be used for some or all components described herein. Examples of thermally conductive materials include pure metals, metal alloys, plastics, ceramics, and other materials. Materials may also be selected to withstand pressures exerted on the materials by an external environment (e.g., a deep, marine environment), varying temperatures of the external environment, and other conditions imposed on the materials by the external environments.

The LED driver circuitry may or may not be a part of the PCB, as dictated by package design, economics, and heat management. The present disclosure may provide the shortest path from the heat sink of a high intensity LED and associated driver circuit, to the environment surrounding the light fixture, with a minimal number of thermal boundaries in between. This configuration may provide a means to efficiently radiate substantial heat away from the light fixture, and into the cool ocean surrounding the light fixture during operation. Thermal grooves may be formed on the exterior surface of the light fixture body or housing to increase the radiant surface area, thereby enhancing and/or improving heat dissipation.

The present disclosure provides LED light fixtures configured for use at significant ocean depths with reduced weight, by incorporating an efficient pressure-resistant interior volume and reduced wall thickness. With its intrinsic ability to balance external forces, a partially or substantially spherical housing may resist increasing ambient pressure encountered at deep sea depths. With reduced wall thickness, the weight of the light fixture housing may be minimized for a given water displacement, thus significantly reducing the submerged water weight of the LED light fixture. The improved LED light fixtures may provide deep sea vehicle designers the option of mounting the LED light fixtures where they are needed with less concern for weight-and-balance of the undersea vehicle. Less buoyancy is needed to float the undersea vehicle, meaning less weight over the side, smaller vehicle size, fewer trim weights, and less time to prep a dive. The reduced wall thickness of the LED light housing may also improve the thermal management of the LED lights. For example, heat may be transferred from the interior electronics to the cold surrounding environment (e.g., the ocean), increasing the light output potential of the system.

In accordance with the present disclosure, an LED light fixture includes an LED PCB having a rear side and a front side. One of skill in the art will appreciate that the LED PCB in each embodiment may be a metal core PCB (MCPCB) or some other PCB. One or more LEDs may be mounted to the front side of the LED PCB. The LED PCB may be mounted

approximately tangential within an aperture formed in a front side of the substantially spherical outer metallic housing. A window made of a transparent material with a high refractive index and thermal conductivity, such as sapphire, may extend across the aperture and may be sealed to the housing. The window may optionally be protected by a window retaining flange (e.g., a plastic flange). Excess heat from the LED PCB may be drawn off by the housing and/or window, and transferred to the surrounding ambient environment (e.g., ocean).

The spherical housing may be constructed using two partially or substantially hemispherical halves that may be assembled using an interior or exterior threaded center coupling element. An LED driver PCB may be suspended by the threaded center coupling element. Excess heat emitted from the LED driver PCB may be drawn off by the threaded center coupling element and transferred to the spherical housing where it may be dissipated into the surrounding environment (e.g., ocean water).

Mounting the LED PCB approximately tangential to the exterior surface of the forward pressure housing may reduce potential degradation of the pressure bearing ability of the substantially spherical shape of the outer housing, while providing ease of electrical connection to the LED driver PCB, and substantial heat sinking of the LED PCB. The use of an aperture with a stepped construction (as shown in several figures) provides several surfaces on the housing to which the LED PCB can transfer thermal energy.

The LED PCB may be mounted at one pole of the forward pressure housing and an electrical interface connector may be mounted at an opposite pole of the aft pressure housing. An LED driver PCB may be attached at the interior equator of the housing—i.e. the plane of maximum cross-section within the spherical outer housing—thereby providing more room for required electronic components. This equatorial attachment may provide a mechanism for cooling by physically decoupling the LED driver PCB heat sinking from the LED PCB heat sinking.

Various additional aspects, details, features, and functions are described below in conjunction with the appended figures.

The following exemplary embodiments are provided for the purpose of illustrating examples of various aspects, details, and functions of apparatus and systems; however, the described embodiments are not intended to be in any way limiting. It will be apparent to one of ordinary skill in the art that various aspects may be implemented in other embodiments within the spirit and scope of the present disclosure.

It is noted that as used herein, the term, “exemplary” means “serving as an example, instance, or illustration.” Any aspect, detail, function, implementation, and/or embodiment described herein as “exemplary” is not necessarily to be construed as preferred or advantageous over other aspects and/or embodiments.

Example Embodiments

Referring to FIG. 1, an embodiment of an underwater LED light fixture **100** in accordance with certain aspects is illustrated. Light fixture **100** may include a pressure housing, which may include one or more components or assemblies, such as a forward pressure housing (or body) **110** and an aft pressure housing (or body) **120**. Forward pressure housing **110** may include a light assembly, which may include one or more components, such as a window retaining flange **114**, which surrounds and protects a transparent panel, such as window **112**, which may be recessed below the level of the

window retaining flange **114**. The window retaining flange **114** may be constructed of strong materials such as plastics or polymers, to provide high impact strength to deflect foreign object impacts and the like.

In a typical embodiment, window **112**, which may extend across the aperture and may be sealed to the housing **110**, may be made of a suitably high strength transparent material, such as glass, acrylic, sapphire, or other suitable material, for providing optical clarity for the passage of light, mechanical strength, such as for example, resistance to external pressure, and heat dissipation. One or more screws, such as a set of six circumferentially spaced machine screws **118**, may be used secure the window retaining flange **114** to the forward pressure housing **110**. The aft pressure housing **120** may include a cylindrical neck **202** (as shown in FIG. 2), and may be surrounded by a mount **126**, which may be used for attaching the light fixture **100** to an underwater structure (not shown). An electrical connector, such as a five-pin underwater electrical connector **130** may be fitted into the neck of the aft pressure housing **120**. For example, electrical connector **130** may include a male threaded segment that screws into a female threaded bore or aperture that extends through the cylindrical neck **202**. Female threads may be disposed on the surface of the connector **130** and/or on a connector locking sleeve **134** (optional) for preventing accidental de-mating of the underwater connector **130** from a power cable (not shown) during normal operations. The connector **130** may also include one or more conductive contact pins **132** for providing power to the circuit boards inside the light fixture **100**. A label, such a tamper-evident label **142**, or a cover may be disposed over the seam where the forward pressure housing **110** and the aft pressure housing **120** mate to indicate and/or deter tampering, to provide an additional permeation barrier, and/or to provide an additional mechanical coupling for the forward and aft housings **110** and **120**. The cover may include a threaded coupler (not shown) with female threads that couple to male threads on the exterior wall of the housings **110** and **120** (not shown). An alternative cover may attach to one or more of the housings **110** and **120** using fasteners, adhesive, tongue-and-groove, a clamping mechanism, or other feature.

Referring again to FIG. 1, one or more drive pin holes, such as a set of two drive pin holes **116** may be used during assembly for engaging the forward pressure housing **110**. The two drive pin holes **116** may pass through the window retaining flange **114** and partially into the forward pressure housing **110**. The mount **126** may typically be made of one or more materials, such as a glass-filled plastic. The forward pressure housing **110** and the aft pressure housing **120** may comprise one or more suitable metals, such as anodized aluminum alloy, beryllium copper, stainless steel, titanium, and the like.

FIGS. 2 and 3 are section views illustrating additional details of the underwater, generally spherical LED light fixture **100**. In an exemplary embodiment, the forward pressure housing **110** and the aft pressure housing **120** may be joined by a coupling element, such as an interior threaded center coupling element **220** to form a generally spherical housing. One of skill in the art will appreciate alternatives to the threaded center coupling element **220**, including an exterior threaded coupling element (e.g., a coupling element with female threads that couples to male threads formed on the exterior walls of the housings **110** and **120**). One of skill in the art will also appreciate that no center coupling element is needed where male threads are formed on one of the housings **110** and **120** and female threads are formed on the other housings **110** or **120** for coupling the two housings **110**

and **120**. One of skill in the art will further appreciate non-threaded coupling elements, including clamps, adhesive materials, etc.

The threaded coupling element **220** may be designed using the same or similar materials as the forward pressure housing **110** and the aft pressure housing **120**. The material of the coupling element **220** may be selected to provide direct heat transfer from the interior of the spherical housing, to the forward and aft pressure housings **110** and **120**, and then to the external environment (e.g., the ocean). In one aspect, the threaded coupling element may be used to suspend one or more PCBs at the equator of the generally spherical housing. For example, a first LED driver PCB **222** may be mounted to the top face of threaded center coupling element **220**, and the second LED driver PCB **224** may be mounted to the bottom face of threaded center coupling element **220**.

Various elements and sub-assemblies may be configured with the forward pressure housing **110** and aft pressure housing **120**, to provide a pressure-resistant and leak-resistant housing having an interior volume that remains dry and at surface air pressure (or some other desired and/or controllable pressure). For example, a sealing element, such as a housing O-ring **228**, may be disposed between forward pressure housing **110** and aft pressure housing **120**. In an exemplary embodiment, housing O-ring **228** may be seated into the annular groove (not shown) disposed on the forward pressure housing **110**, and compressed in assembly between forward pressure housing **110** and aft pressure housing **120** to provide a seal at the interface or seam. A sealing element, such as connector O-ring **212**, may be disposed between the connector **130** and the aft pressure housing **120**. A sealing element, such as window O-ring **232** may be disposed between the window **112** and a surface of the forward pressure housing **110**, and secured by window retaining flange **114**. For example, in assembly, the window retaining flange **114** and screws **118** may be configured with the forward pressure housing **110**, such that window O-ring **232** is clamped between window **112** and a surface of the forward pressure housing **110**, to provide the water-tight seal. In some embodiments, the O-rings may assist in the transfer of thermal heat.

The mount **126** clamps to the exterior of the cylindrical neck **202** of aft pressure housing **120**. In an alternate embodiment (not shown), the mount **126** may be configured to alternatively or to also grip an exterior section of the forward pressure housing **110**. In yet another embodiment (not shown), the mount **126** may be configured to alternatively or to also grip exterior sections of the forward and aft pressure housings **110** and **120** where those housings **110** and **120** mate. Such an embodiment would provide additional mechanical strength for coupling the housings **110** and **120**, and would provide more exterior surface area in contact with the external environment (e.g., the ocean) for transferring thermal energy to that external environment from the interior of the generally spherical housing. Electrical power may be provided to the light fixture through one or more contact pins **132** of the underwater connector **130**.

Referring again to FIG. 3, the set of two drive pin holes **116** may extend through the window retaining flange **114** and partially into the forward pressure housing **110** to provide an aperture for engaging and turning the forward pressure housing **110**. One of skill in the art will appreciate that other mechanical features of the present invention may be used to turn the forward pressure housing **110**.

FIG. 4 illustrates additional details of an equatorial region **400** (e.g., region **4** in FIG. 2) of the underwater LED light

fixture 100. In an exemplary embodiment, the forward pressure housing 110 and the aft pressure housing 120 may be joined by the threaded center coupling element 220, and sealed by the housing O-ring 228. Male threads 406 formed on the threaded center coupling element 220 may engage female threads 404 on the forward pressure housing 110 and female threads 408 of the aft pressure housing 120, for providing varying degrees of mechanical strength depending on the density and surface area coverage of the threads 404, 406 and 408. The threads 404-408 also direct thermal transfer from the threaded center coupling element 220 to the external environment (e.g., the ocean). The tamper-evident label or impermeable cover 142 is attached (e.g., via adhesion, mechanical fastening, or other means), and covers the seam between the forward pressure housing 110 and the aft pressure housing 120.

First PCB 222 and second PCB 224 may be joined together with one or more screws 412, and mounted into a PCB carrier that may be disposed along the equator of the spherical housing.

FIG. 5 illustrates additional details of an LED light fixture sub-assembly 500 as shown in FIG. 2. In an exemplary embodiment, a sealing element, such as window O-ring 232 may be disposed between the window 112 and an outer circular section 502 of the forward pressure housing 110, and secured by window retaining flange 114. For example, in assembly, the window retaining flange 114 and screws 118 may be configured with the forward pressure housing 110, such that window O-ring 232 is clamped between window 112 and outer circular section 502 to provide a water-tight seal. One or more high brightness LEDs 512 may be disposed on the outward facing side of an LED PCB, such as LED PCB 510, which may be seated in a stepped aperture or bore 516 formed into the front side of the forward pressure housing 110.

A circular reflector body 522 may be disposed between the window 112 and the LED PCB 510 for redirecting light through window 112. Circular reflector plate 522 may be made of molded plastic, or other similar or equivalent materials. This stack of components, which may include LED PCB 510, LEDs 512, and circular reflector body 522, may be restrained by a circular metallic spring 532 that presses against the inside face of the window 112, transfers thermal energy to the window 112 and the forward housing 110, and clamps the LED PCB 510 to the forward housing 110 for heat transfer.

The LED PCB 510 may be supported by an inner circular section 504 of the forward pressure housing 110. A layer of phase change material (PCM) 526, such as Tmate™ 2900 Series, or other similar or equivalent materials, may be used for providing enhanced thermal coupling to the forward pressure housing 110. An air gap 528 disposed between the LED PCB 510 and the forward pressure housing 110 may provide electrical insulation. The air gap 528 may be configured to provide only an annular air gap around the outer diameter of the LED PCB 510. Electrical power for the LEDs 512 may be provided by one or more spring contacts 534. The stepped configuration of the bore 516 forms a cavity into which the LED PCB and LEDs are inserted, and allows for the aperture through the front side of the forward pressure housing 110 to be minimal in size since only the spring contacts 534 need to pass there through. By minimizing the size of the aperture, a desired level of strength of the generally spherical housing formed by the joined body halves 110 and 120 is achieved.

In alternative embodiments (not shown), the LED PCB may be positioned inside the interior of the housing, where

no bore is needed and the aperture is sized with a diameter large enough to allow light from the LEDs to pass through the aperture and the window. In such embodiments, an annular portion of the window may be designed to fit around a corresponding annular portion of the exterior wall of the forward housing (e.g., the portion of the window may match the curvature or flatness of the portion of the forward housing's exterior wall). Annular grooves may be cut into the exterior surface of the forward housing to receive an O-ring for creating a watertight seal between the window and the forward housing.

In one aspect, the central plane of the LED PCB 510 may be positioned and supported in an approximate tangential relationship to the outer diameter (OD) of the forward pressure housing 110. This placement may vary between one and two wall thicknesses (i.e., between two wall surfaces) of the forward pressure housing 110, such that the addition of the window 112 does not affect the inherent pressure resistance of the spherical housing body.

FIG. 6 illustrates an alternate embodiment underwater LED light fixture 600, which may correspond with various aspects of embodiment 600 as shown in FIGS. 1-3. In an exemplary embodiment, LED light fixture 600 is shown to include a forward pressure housing 610, and a window 612 that may be larger in diameter than window 112. FIG. 6 also illustrates a crash guard 614 which may be retained by a plurality of fasteners 618 (e.g., plastic set screws). In accordance with one aspect of FIG. 6, crash guard 614 may include one or more vent holes 616 configured to provide flow through of ambient fluid (e.g., seawater) for enhanced cooling.

An aft pressure housing 620, which may correspond with details of aft pressure housing 120, may be mated to forward pressure housing 610 in a similar fashion to that set forth in the preceding text. A mount bracket 626, which may correspond to mount 126, may be clamped around a portion of the aft housing 620, the forward housing 610 or both. The LED light fixture 600 may receive electrical power from various components, such as a power cable (not shown), and an electrical connector 630 (e.g., a five-pin underwater electrical connector), which may correspond to electrical connector 130. For example, underwater electrical connector 630 may include one or more conductive contact pins 632 and a cylindrical sleeve 634, which may correspond with conductive contact pins 132 and cylindrical sleeve 134. A tamper-evident label or other cover 642, may be used to indicate and/or deter tampering, or to further couple the forward and aft housings 610 and 620.

FIG. 7 illustrates additional details associated with the LED light fixture 600. Details of LED light fixture 600 may correspond with the embodiments described in the preceding examples. For example, forward pressure housing 610 and the aft pressure housing 620 may be joined by a threaded center coupling element 720, which may correspond with threaded center coupling element 220, and sealed with a housing O-ring 728, which may correspond to housing O-ring 228. A window O-ring 732, which may correspond to 232, may be disposed between the window 612 and a surface of the forward pressure housing 610 to provide a water-tight seal. The underwater electrical connector 630 may be sealed to the aft pressure housing 620 by a connector O-ring 712, which may correspond to electrical connector O-ring 212. The mount 626 may clamp around an outer housing of a cylindrical neck 708 which, provides the threaded segment for receiving the threaded length 706 of the underwater

electrical connector **630**. In an exemplary embodiment, LED light fixture **600** may include, for example, a single mounted LED driver PCB **722**.

FIG. **8** is an enlarged section view of the LED light fixture **600** of FIG. **7** illustrating details of an LED light fixture sub-assembly **800**. In an exemplary embodiment, a spring collar **810** may capture and press window **612** against a light assembly, such as a stack light assembly **820**, which may be stacked and mounted in the forward pressure housing **610** with one or more screws **822**. The stack light assembly **820** may be constructed in the manner disclosed in U.S. patent application Ser. No. 12/844,759 of Mark S. Olsson, et al., filed Jul. 27, 2010 entitled SUBMERSIBLE LED LIGHT FIXTURE WITH MULTILAYER STACK FOR PRESSURE TRANSFER, the entire disclosure of which is hereby incorporated by reference. The spring collar **810** may include a series of male threads **812** for engaging a series of female threads **802** disposed on the forward pressure housing **610** for providing compression force. The interior face of a stack light assembly **820** may be positioned approximately tangent to the spherical outer diameter (OD) of the forward pressure housing **610**. This placement may vary between one and two wall thicknesses (i.e., between two wall surfaces), as described in connection with FIG. **5**.

Window **612** may be sealed to the forward pressure housing **610** by a window O-ring **732**. Window **612** may be made of a strong transparent material with a high refractive index and/or thermal conductivity. The window may be made of various materials, including sapphire, acrylic, polycarbonate resin or other similar or equivalent materials for providing optical clarity, high strength to resist external pressure, and for dissipating excess heat into the ambient environment (e.g., cold ocean). The window **612** may be protected from incidental side impact by the crash guard **614**. The crash guard **614** may be generally cylindrical, and may be molded of plastic to provide high impact strength for deflecting foreign object impacts.

FIG. **9** illustrates an alternate embodiment underwater LED light fixture **900**, which may correspond with various aspects of embodiment 100 as shown in FIGS. **1-5**, and embodiment 600 as shown in FIGS. **6-8**. In an exemplary embodiment, LED light fixture **900** may include a forward pressure housing **910**. For example, forward pressure housing **910** may be configured with a window **912**, which may be made of a suitably high strength transparent material, such as glass, acrylic, sapphire, or other suitable material, as well as a crash guard **914** for retaining the window **912** and other elements, which may be secured by one or more fasteners **918**, such as plastic set screws. Crash guard **914** may include one or more vent holes **916** configured to provide flow through of ambient fluid (e.g., seawater) for enhanced cooling.

An aft pressure housing **920** may be mated to forward pressure housing **910** in manners similar to those set forth in the preceding examples. For example, a mount bracket **926** may be clamped around a surface of the aft pressure housing **920**. A tamper-evident label or other cover **942** may be used to indicate and/or deter tampering, to provide an impermeable structure at the seam between the forward and aft housings **910** and **920**, and/or provide an additional or alternative mechanical coupling for the forward and aft housings **910** and **920**.

FIGS. **10** and **11** illustrate additional details of the LED light fixture **900**. Details of LED light fixture **900** may correspond with the embodiments described in the preceding examples. For example, forward pressure housing **910** and the aft pressure housing **920** may be joined by a threaded

center coupling element **1020** and sealed with a housing O-ring **1028**. A window O-ring **1026** may be disposed between window **912** and a surface of the forward pressure housing **910** to provide a water-tight seal.

An underwater electrical connector **1030**, such as a three-pin underwater electrical connector may be sealed to the aft pressure housing **920** by a connector O-ring **1012**.

In an exemplary embodiment, one or more PCBs, such as a lower LED PCB driver **1006**, and an upper LED PCB driver **1008**, may be disposed in the interior of the LED light fixture **900**. Lower LED PCB driver **1006** may be disposed in the aft pressure housing, and mounted to a surface of a thermally-conductive plug **1002** (which may be press fit inside the aft housing **920**), with one or more screws **1014**, which may thermally connect various elements to the generally spherical housing to dissipate heat from the interior of the LED light fixture **900** and away from other heat producing elements in the forward section, such as an LED MCPCB or a stack light assembly (e.g., assembly **1220** in FIG. **12**). One or more wire wound resistor cores **1004** may be disposed inside one or more holes formed into the thermally-conductive plug **1002**, as shown in FIG. **11**. Thermally-conductive plug **1002** may, for example, be made of metal, such as an aluminum alloy, or other equivalent material. An alternate heat sinking path may be provided through the thermally conductive plug **1002**, allowing heat to transport out from the LED PCB driver **1006** to the aft housing **920**. Thermally-conductive grease (not shown) may be used to enhance any thermal path to the aft housing **920** (e.g., grease in association with the wound resistor cores **1004**).

The threaded length **1034** of electrical connector **1030** may be screwed into cylindrical neck **1038** of aft pressure housing **920**. Thermally-conductive plug **1002** and forward pressure housing **910** may be coupled or press fit. A thermally-conductive material may be disposed between the inner surface of the lower body **920** and the outer surface of the thermally-conductive plug **1002** for enhancing thermal coupling.

Upper LED PCB driver **1008** may be disposed in the forward pressure housing **910** and mounted into one or more spacers **1016** with one or more fasteners (e.g., one or more screws), which may be disposed in forward pressure housing **910**. The spacers **1016** also couple to the coupling element **1020**. Various elements may be disposed on upper LED PCB driver **1008**. Such elements may include a MOSFET, a capacitor and a resistor. To optimize the thermal efficiency of the generally spherical housing, a separate thermal path from each or combined heat producers in the interior of the LED light fixture **900** may be provided.

A copper alloy strap may be attached to the spacers **1016** for conducting heat from the LED PCB driver **1008** or other components in the lighting fixture to the coupling element **1020** and housings. FIG. **10** also illustrates an internal capacitor (at center, between the two PCBs **1006** and **1008**) and mounted on the PCB **1008**. Thermal energy may be drawn from the capacitor to the copper alloy straps on the spacers **1016**. FIG. **13** illustrates details of such a thermal pathway consisting of a flexed thermally conductive metal strap **1397** in direct thermal contact with a capacitor **1399** (or another circuit element) and one or more spacers **1016**, which couple thermal energy to the threaded center coupling element **1020** and out into the surrounding environment through the forward pressure housing **910** and aft pressure housing **920**. The capacitor **1399** may be an electrolytic type packaged in an aluminum housing covered by a plastic wrap. Typically, it heats up under normal use. By using the alloy

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strap **1397** to conduct some of that heat away from the capacitor **1399**, an increase in the mean time before failure of the capacitor **1399** may be achieved.

FIG. 12 is an enlarged section view of an LED light fixture sub-assembly **1200**, which may correspond with details of LED light fixture **900** as shown in FIG. 9. For example, a spring collar **1210** may capture and press window **912** against a light assembly, such as a stack light assembly **1220**, which may be stacked and mounted in the forward pressure housing **910** with one or more fasteners **1222**. The stack light assembly **1220** may be constructed in the manner disclosed in U.S. patent application Ser. No. 12/844,759 of Mark S. Olsson, et al., filed Jul. 27, 2010 entitled SUBMERSIBLE LED LIGHT FIXTURE WITH MULTILAYER STACK FOR PRESSURE TRANSFER, the entire disclosure of which is hereby incorporated by reference. The spring collar **1210** may include a series of male threads **1212** for engaging a series of female threads **1202** disposed on the forward pressure housing **910** for providing compression force and thermal transfer. The interior face of a stack light assembly **1220** may be positioned approximately tangential to the spherical outer diameter (OD) of the forward pressure housing **610**.

A generally spherical housing may refer to a substantially spherical housing, wherein at least ninety percent of the housing's exterior surface(s) is/(are) spherical (e.g., allowing for some non-spherical elements), a partially spherical housing, wherein less than ninety percent, but greater than fifty percent of the housing's exterior surface(s) is/(are) spherical, or any other proportionally-spherical housing.

The stacking of elements behind the window may be accomplished externally from the housing (e.g., into the

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bore using an exterior loading approach) or internally within the housing (e.g., insertion behind the window from the rear opening of the forward housing/body).

While various embodiments of the present underwater LED spherical light fixture have been described in detail, it will be apparent to those skilled in the art that the present invention can be embodied in various other forms not specifically described herein. Therefore the protection afforded the present invention should only be limited in accordance with the following claims and their equivalents.

We claim:

1. A submersible LED light for deep ocean use, comprising:
 - a pressure and leak resistant housing structured to withstand ambient exterior water pressures corresponding to liquid depths of approximately 1000 meters or more;
 - a transparent pressure bearing window positioned in the forward end of the housing and extending across an aperture therein;
 - an MCPCB including an LED driver circuit and a plurality of LEDs disposed within the housing adjacent to the aperture so as to pass light through the aperture and the transparent pressure bearing window; and
 - a multilayer stack of spacers of a high compressive strength material comprising one or more of a PEEK plastic, ULTEM resin, ceramic, and metal positioned between the window and the MCPCB for transferring substantially all loading applied to the window from the ambient exterior water pressure to the MCPCB and to the housing.

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